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09/720,761	03/26/2001	Franz Laermer	10191/1629	5642
26646	7590 11/06/2002			
KENYON & KENYON			EXAMINER	
ONE BROAI NEW YORK			CHEN, KIN CHAN	
			ART UNIT	PAPER NUMBER
			1765	7
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Please find below and/or attached an Office communication concerning this application or proceeding.

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	Application No.	A. icant(s)	, , ,
	09/720,761	LAERMER ET AL.	
Office Action Summary	Examiner	Art Unit	
	Kin-Chan Chen	1765	
The MAILING DATE of this communication	n appears on the cover sheet	with the correspondence addre	ess
A SHORTENED STATUTORY PERIOD FOR F THE MAILING DATE OF THIS COMMUNICAT - Extensions of time may be available under the provisions of 37 of after SIX (6) MONTHS from the mailing date of this communicat If the period for reply specified above is less than thirty (30) days If NO period for reply is specified above, the maximum statutory Failure to reply within the set or extended period for reply will, by Any reply received by the Office later than three months after the earned patent term adjustment. See 37 CFR 1.704(b).	ION. CFR 1.136(a). In no event, however, may ion. s, a reply within the statutory minimum of period will apply and will expire SIX (6) Note that the representation to become	a reply be timely filed thirty (30) days will be considered timely IONTHS from the mailing date of this come ABANDONED (35 U.S.C. § 133).	munication.
tatus 1) Responsive to communication(s) filed o	n .		
26/5	·· ☑ This action is non-final.		
Za) This determine in the condition for	allowance except for formal I	natters, prosecution as to the	ments is
3) Since this application is in condition for closed in accordance with the practice disposition of Claims	under <i>Ex parte Quayle</i> , 1935	C.D. 11, 453 O.G. 213.	
4) Claim(s) 19-36 is/are pending in the app	olication.		
4a) Of the above claim(s) is/are w	ithdrawn from consideration.		
5) Claim(s) is/are allowed.			
6) ☐ Claim(s) <u>19-36</u> is/are rejected.			
7) Claim(s) is/are objected to.			
8) Claim(s) are subject to restriction	and/or election requirement.		
Application Papers			
9)∑ The specification is objected to by the Ex	kaminer.	hutha Evaminar	
10) The drawing(s) filed on is/are: a)	accepted or b) objected to	by the Examiner.	
Applicant may not request that any objection	on to the drawing(s) be held in a	disapproved by the Examine	r
11) The proposed drawing correction filed or	nis: a)∐ approved b)[disapproved by the Examine	
If approved, corrected drawings are require			
12)☐ The oath or declaration is objected to by	the Examiner.		
Priority under 35 U.S.C. §§ 119 and 120		0 0 440(a) (d) or (f)	
13) Acknowledgment is made of a claim for	r foreign priority under 35 U.S	.C. 9 119(a)-(u) or (i).	
a)∑ All b) Some * c) None of:			
1. Certified copies of the priority do	cuments have been received		
2. Certified copies of the priority do	cuments have been received	in Application No	Stage
3. Copies of the certified copies of application from the Internati * See the attached detailed Office action f	onal Bureau (PC) Ruic 17.20	α//.	Stage
14) Acknowledgment is made of a claim for	domestic priority under 35 U.	S.C. § 119(e) (to a provisional	application)
a) ☐ The translation of the foreign langu 15)☐ Acknowledgment is made of a claim for	rage provisional application h	las been received.	
Attachment(s)			
1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTC 3) Information Disclosure Statement(s) (PTO-1449) Paper	o-948) 5) Not	rview Summary (PTO-413) Paper No ice of Informal Patent Application (PT er:	(s)
J.S. Patent and Trademark Office	Office Action Cummary	Part o	of Paper No. 7

Art Unit: 1765

DETAILED ACTION

Specification

1. The specification is objected to as failing to provide proper antecedent basis for the claimed subject matter. See 37 CFR 1.75(d)(1) and MPEP § 608.01(o). Correction of the following is required: In claim 22, line 2, "fluoroalcane" is not described in the specification.

Claim Rejections - 35 USC § 112

- The following is a quotation of the second paragraph of 35 U.S.C. 112:
 The specification shall conclude with one or more claims particularly pointing out and distinctly claiming the subject matter which the applicant regards as his invention.
- 3. Claims 19, 24, 29, and 34 recite the limitation "prior to / or during the anisotropic plasma etching" in lines 4 and 5. There is insufficient antecedent basis for this limitation in the claim because there is no etching step in the process.

Claims 19-36 recite the limitation "the process gas". There is insufficient antecedent basis for this limitation in the claim because there is no etching step in the process, it is unclear how process gas works.

4. Claims 19-36 are rejected under 35 U.S.C. 112, second paragraph, as being indefinite for failing to particularly point out and distinctly claim the subject matter which applicant regards as the invention.

Application/Control Number: 09/720,761 Page 3

Art Unit: 1765

In claims 19-21, 25-27, 30-32, and 34-36, "selected from the group of" is vague and indefinite because it is unclear as to the scope of the claim. The examiner suggests replace it with -- selected from the group consisting of--.

In claims 19-21, 25-27, 30-32, and 34-36, "at least from time to time" is vague and indefinite because it is unclear what, if anything, differentiates the process step with or without said phrase.

In claim 22, line 2, "fluoroalcane" is vague and indefinite because the meaning is unclear.

In claims 22, 24, and 33, "Teflon-type material" is vague and indefinite because it is unclear what "type" was intended to convey.

In claims 21, 32, and 36, " NO_x " is vague and indefinite because it is unclear what "x" was intended to convey.

In claims 23, 28, 29, and 34, "light and easily " is a relative term with no basis for comparison. Thus the metes and bounds of the claim are unclear.

Claim Rejections - 35 USC § 103

5. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

⁽a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Application/Control Number: 09/720,761

Art Unit: 1765

6. Claims 19-22 and 24-27 are rejected under under 35 U.S.C. 103(a) as obvious over Flamm et al (Journal of the Electrochemical Society, Dec. 1982, USA Bd 129, Nr.12, Page 2755-2760).

Flamm teaches a method of anisotropic plasma etching a laterally defined structure in as silicon substrate using a process gas. Flamm teaches adding a fluorinedelivering etching gas to the process gas. The fluorine-delivering etching gas may include NF₃, CIF₃ or BrF₃ (page 2756, col. 1, full paragraph 3). Flamm also teaches that plasma in a wide range of gas mixtures including CF_4 , CF_4 / O_2 and C_2F_6 / O_2 (instant claims 20, 21, 22, 26, and 27) can be used to supply fluorine atoms for selective isotropic silicon etching. The said gas mixtures can deposit polymer (so-called precipitating at least one passivating material in the instant claims), see page 2755, col. 1 and 2). Because it is known that gas comprising CF₄ or C₂F₆ can supply fluorine atoms for selective isotropic silicon etching and deposit polymer and because it is disclosed by Flamm, hence, it would have been obvious to one with ordinary skill in the art to incorporate gas mixtures including CF₄/O₂ and C₂F₆/O₂ in the method of etching silicon using the fluorine-delivering etching gas including NF_3 , CIF_3 or BrF_3 (instant claims 19, 24, 25) and use them in any combinations thereof in order to provide their art recognized advantages and produce an expected result since they have been taught to be useful for the same purpose (etching silicon sbustrate).

Application/Control Number: 09/720,761

Art Unit: 1765

7. Claims 23 and 28-36 are rejected under 35 U.S.C. 103(a) as being unpatentable over Flamm et al. as applied to claims 19-22 and 24-27 above, and further in view of Charlet et al. (US 5,047,115).

Flamm teaches a method of anisotropic plasma etching a laterally defined structure in as silicon substrate using a process gas. Flamm teaches adding a fluorine-delivering etching gas to the process gas. The fluorine-delivering etching gas may include NF3, CIF3 or BrF3 (page 2756, col. 1, full paragraph 3). Flamm also teaches that plasma in a wide range of gas mixtures including CF4, CF4/ O_2 and C_2F_6/O_2 can be used to supply fluorine atoms for selective isotropic silicon etching. The said gas mixtures can deposit polymer (so-called precipitating at least one passivating material in the instant claims 29, 31, 33, 34), see page 2755, col. 1 and 2. Because it is known that gas comprising CF4 or C_2F_6 can supply fluorine atoms for selective isotropic silicon etching and deposit polymer and because it is disclosed by Flamm, hence, it would have been obvious to one with ordinary skill in the art to add gas mixtures including CF4 $/O_2$ and C_2F_6/O_2 (instant claims 30, 31, 32, 33, 35, 36) in the method of etching silicon using the fluorine-delivering etching gas including NF3, CIF3 or BrF3 (instant claims 25, 30, 34) in order to provide their art recognized advantages and produce an expected result.

Unlike the claimed invention, Flamm does not disclose that He or Ne may be used in the process of etching silicon substrate. In the method of etching silicon substrate, Charlet teaches that helium or argon (instant claims 23, 28, 29, 34) may be used in the process of etching silicon substrate so as to ensure the stability of the

Application/Control Number: 09/720,761

Art Unit: 1765

Page 6

discharge and its extension to the substrate (col. 2, lines 65-68). Hence, it would have been obvious to one with ordinary skill in the art to incorporate helium or argon as taught by Charlet in order to ensure the stability of the discharge and its extension to the substrate.

8. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Kin-Chan Chen whose telephone number is (703) 305-0222. If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Benjamin Utech can be reached on (703) 308-3836. The fax phone numbers for the organization where this application or proceeding is assigned are (703) 872-9310 for regular communications and (703) 872-9311 for After Final communications. Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the receptionist whose telephone number is (703) 308-2934.

K-C C October **3**1, 2002 Patent Examiner Group Art Unit 1765